









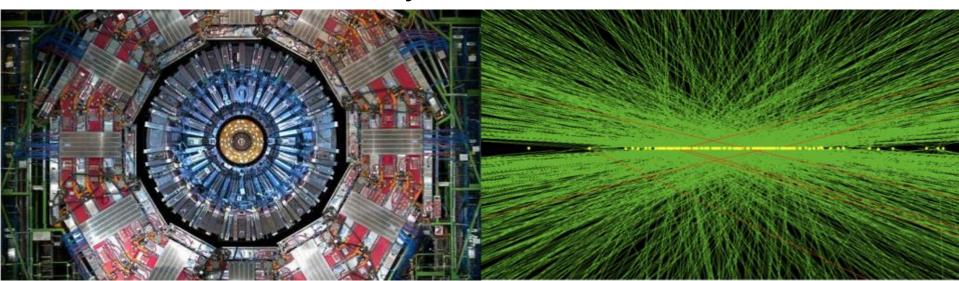


High rate capability studies of triple-GEM detectors for the MEO upgrade of the CMS muon spectrometer

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PSD12: The International Conference on Position Sensitive Detectors. 2021





Introduction

Goals of this presentation

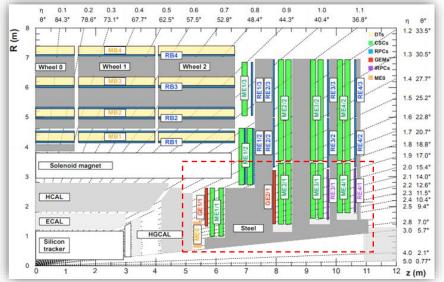
To share the latest results of the R&D and prototype phase of the MEO muon station of the Compact Muon Solenoid (CMS). In particular, we will present the rate capability studies and the new design of the MEO detectors.

Table of Contents:

- Introduction to CMS and the GEM technology.
- The ME0 muon project.
- Rate capability studies for large-area GEM detectors.
- New foil design for the ME0 detectors.
- Conclusions.



Introduction to CMS and the GEM technology.



An R-z cross section of a quadrant of the CMS detector, including the Phase-2 upgrades (RE3/1, RE4/1, GE1/1, GE2/1, ME0).

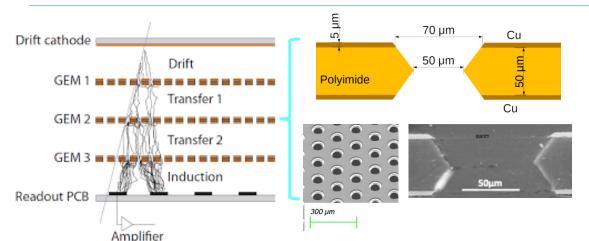
The compact muon solenoid (**CMS**) experiment is one of the particle detectors of the Large Hadron Collider (**LHC**).

Muon system upgrade with **GEM** technology to improve the muon trigger and tracking performance.

GE1/1: $1.55 < |\eta| < 2.18$. LS2: 2019-2021

GE2/1: $1.62 < |\eta| < 2.43$.

MEO: $2.0 < |\eta| < 2.8$. (increases muon coverage)

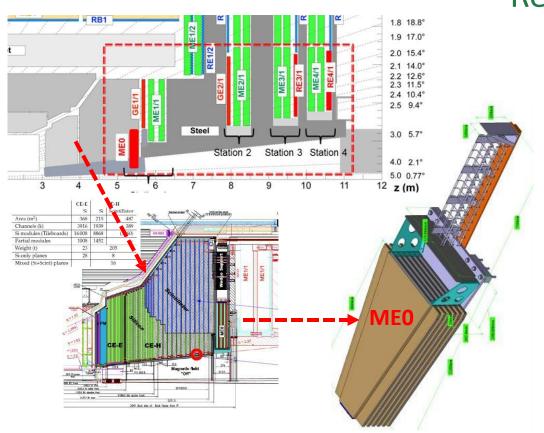


Gas Electron Multiplier (GEM)

- ✓ Electron amplification.
- ✓ Triple GEM: amplification ~10⁵.
- ✓ Particle rate up to O(kHz·cm⁻²)
- ✓ High spatial resolution: ~100µm.
- ✓ Time resolution < 10 ns.
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- ✓ Detection efficiency > 98%.



CMS GEM ME0 Project: challenges



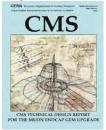
6-Layer Triple-GEM stack installed behind HGCAL (complex environment)

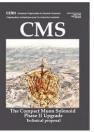
 2×18 stacks (20°) covering $2.0 < \eta < 2.8$

Requirements*:

- 97% module efficiency
- $< 500 \, \mu rad$ resolution
- $8 10 \, ns$ time resolution
- $\leq 15\%$ gain uniformity
- Work in high-rate environment: 150 kHz/cm²*
- Survive harsh radiation environment: 7.9 C/cm²*
- Discharge rate that does not impede performance or operation

* updated w.r.t. TP & TDR





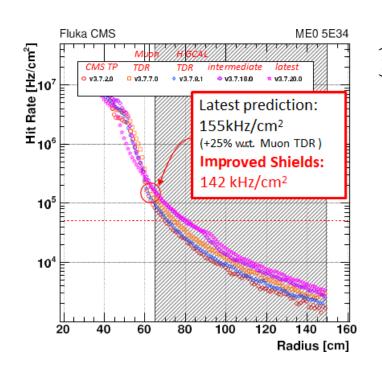


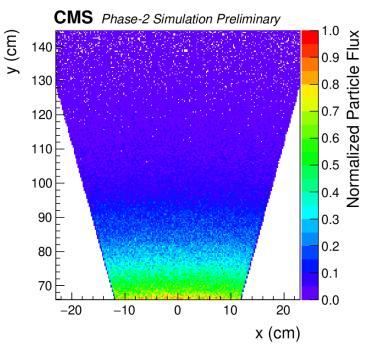


CMS GEM ME0 Project: challenges

Expected background flux in the CMS environment

- Expected background particle hit rate in the highest eta region: $\sim 150 kHz/cm^2$.
- The simulated background hit rate can be updated.
- Total chamber surface: $\sim 2.9 \times 10^3 cm^2$
- Average chamber hit rate: 23.95 kHz/cm² (extracted from Geant4 simulation)







State of art on the rate capability studies

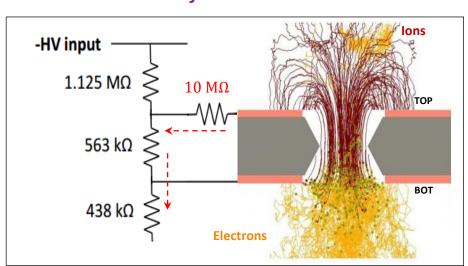
Two main phenomena could affect the rate capability of a GEM-based detector:

- 1) the *space charge*, which could modify the electric fields, resulting in a reduction of the gas gain above a certain value of radiation flux
 - → the *slowly moving ions* are *quickly evacuated* minimizing the space charge effect and improving the rate capability by several orders of magnitude w.r.t. the MWPCs
- 2) the *ion-induced current*, which could flow through the protect. resistors and induce a voltage drop across the GEM-foil, resulting in a decrease of the gas gain
 - → this current is basically due to the *high number of ions* collected on the top electrode of the GEM-foils during the high-flux irradiation
 - → the voltage drop strongly depends on the value of the protection resistors and percentage of the irradiated area, as well as the radiation flux

We want to validate the following points ...

- rather than the space charge, the ion-induced current, flowing through the protect. resistors, strongly affects the detector rate capability!
- a **local irradiation** $O(3 mm^2)$ is drastically different to a **global irradiation** $O(3000 cm^2)!$

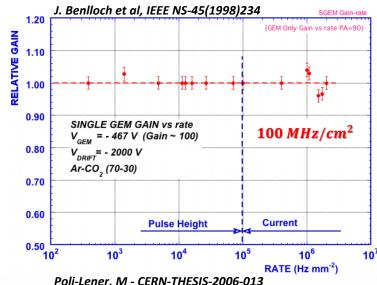
A new approach to the study of rate capability for large-area GEM detector is needed!

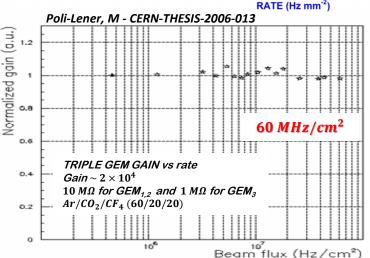




State of art on the rate capability studies

The *rate capability* of GEM-based detectors has been extensively studied in the last decade for different sizes, geometries, and configurations





Common experimental procedure:

- 1) source: X-ray generator (soft X-ray photons)
- 2) irradiated area: $\approx mm^2$ \rightarrow reaching very high X-ray flux
- 3) gain remains stable up to a flux above MHz/cm^2
 - → demonstrating the absence of space charge phenomena!

but one observes ...

- 1) a low ion-induced current flowing through the protection resistors due to the small irradiated area
 → inconsistent with a real experiment
- 2) a *negligible voltage drop* across the GEM-foils
 - \rightarrow as a result: high-rate capability up to tens or hundreds of MHz/cm^2



New approach to the rate capability study

- When the detector is globally irradiated:
 - → a **high ion-induced current** is expected to flow through the **protection resistors** due to the large irradiated detector area (consistent with a real experiment)
 - \rightarrow a **significant voltage drop** is expected across the GEM-foils (as a result: low rate capability up to few kHz/cm^2)
- 2) two Ag-target X-ray tubes ($\sim 22 \ keV$ photons) are used to study the rate capability
- 3) a *rate measurement* is fully performed in *current mode* instead of counting mode!
 - → at very high count rates some piled-up pulses could reach the *electronic chain* saturation limit (preamp. + amp. + shaper) and affect the final result
- 4) a *gas gain drop* is estimated:
 - by measuring the *anode current density* and extrapolating the *interaction photons flux* during the high-flux irradiation, and estimating the gas gain drop with the usual formula:

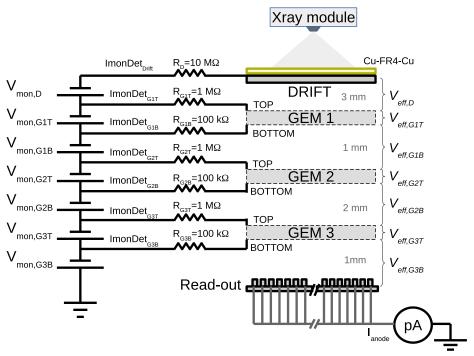
- by measuring the voltage drop across the three GEM-foils during the high-flux irradiation:
 - → the foils are powered individually using a **CAEN A1515TG multi-channel power supply**
 - → the A1515TG module allows to monitor the ion-induced current flowing through the protection resistors, and estimate the voltage drop across the foil, resulting in the gas gain drop:

$$V_{eff}^{electrode} = V_{mon}^{electrode} - I_{mon}^{electrode} \times R^{electrode}$$



Experimental Setup for High-Rate Studies

Experimental Setup for High-Rate Studies at 904 Laboratory (CERN)



 $10 \times 10 \ cm^2$ Triple GEM prototype (with ME0-like material budget)

DETECTOR:

- $10 \times 10 \ cm^2$ Triple GEM prototype
- Gap configuration: 3/1/2/1 mm
- Gas mixture: Ar/CO_2 (70: 30)
- $10 M\Omega$ resistor on Drift board
- $1 M\Omega$ resistor on top (for each foil)
- $100 k\Omega$ resistor on bottom (for each foil)
- ME0 Material (Cu FR4 Cu)

POWER SUPPLY:

 CAEN A1515TG multichannel board on SY1527 system

RADIATION SOURCE:

- Two Amptek Mini-X2 X-Ray tubes (Silver target)
- Operating voltage: 40 kV
- Operating current: from 5 μA to 100 μA
- Number of primaries per hit: 418 ± 9
- Irradiation distances: 0 to 110 cm



Data Analysis (I): Extrapolated Interaction Flux

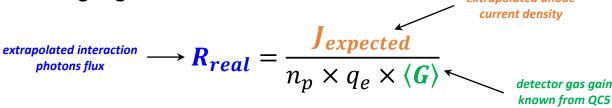
The rate measurement is fully performed in current mode using a pico-ammeter:

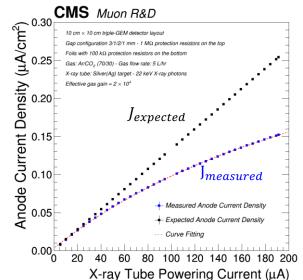
- 1) for a *low particle flux* (i.e. low X-ray powering current), the anode current increases linearly with the increasing count rates
- 2) for a *high particle flux* (i.e. high X-ray powering current), the anode current nearly saturates with the increasing count rates
 - \rightarrow the saturation is exclusively due to gas gain drop!
 - → a curve fitting is used for parameterizing the experimental data and allows to extrapolate the expected (real) anode current:

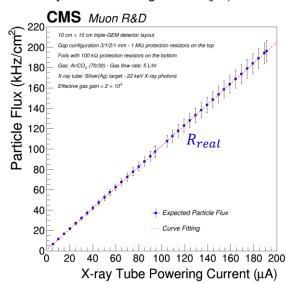
$$J_{measured} = \frac{J_{expected}}{1+k J_{expected}}$$
 with $J_{expected} = A I_{xray} + B$

3) At fixed X-ray powering current, the **extrapolated interaction X-ray photon flux** is given by inverting
the gas gain formula:

extrapolated anode









Data Analysis (II): Effective Gas Gain Drop

The **gas gain drop** is estimated by measuring the **anode current density** and extrapolating the **interaction photons flux** during the high-flux irradiation, and estimating the gas gain drop with the usual formula:

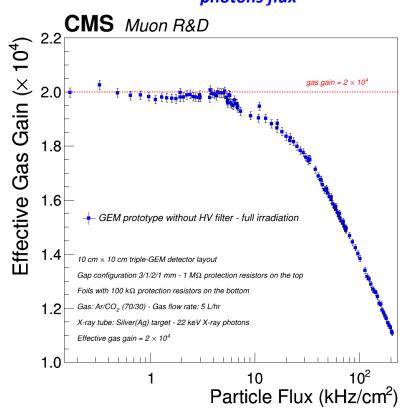
$$\frac{\text{detector effective}}{\text{gas gain}} \longrightarrow \langle \textbf{\textit{G}} \rangle = \frac{\textbf{\textit{J}}_{measured}}{n_p \times q_e \times \textbf{\textit{R}}_{real}} \underbrace{\text{current density}}_{\text{extrapolated interaction}} \underbrace{\text{extrapolated interaction}}_{\text{photons flux}}$$

Experimental Setup Configuration:

- X-ray generator is placed at 15, 30, 110 cm from the detector (no attenuators used)
- X-ray flux is generated along all the dynamic range of the guns (5 to $100 \mu A$ each)
- 10 cm × 10 cm detector active area is fully and uniformly irradiated
- No resistive HV filter!

gas gain drop of 45% @ $200~kHz/cm^2$

Rate Capability is 2 to 3 orders of magnitude lower than the expected one





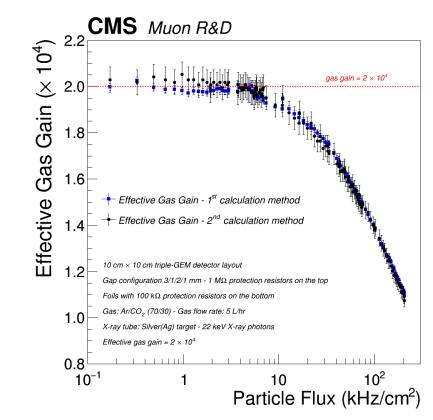
Data Analysis (II): Efective Gas Gain Drop

The gas gain drop is also estimated by measuring the voltage drop across the three GEM-foils during the high-flux irradiation

the current flowing through the protect. resistors changes the voltage on each electode
 → by applying the Kirchhoff's second law, the effective voltage on the electrode will be:

$$V_{eff}^{electrode} = V_{mon}^{electrode} - I_{mon}^{electrode} \times R^{electrode}$$

- 2) the *effective gas gain* is measured by powering the detector with the *effective* voltages ($V_{eff}^{electrode}$) and irradiating with low X-ray photon flux ($\sim 100~Hz/cm^2$)
- The gas gain curve taken by "emulating" the voltages under irradiation is consistent to the one measured under irradiation.
- The gas gain drop is only due to the voltage drop across the resistance.





Data Analysis (III): Gas Gain Compensation

A *compensation measurement* is performed to determine the *new bias voltage* at which the detector should be powered during the high-flux irradiation:

- 1. to recover the original *nominal gas gain* of 2×10^4
- 2. to maintain the *nominal electric fields* between the foils and gaps

Compensation algorithm:

I. Measure the $V_{bias}^{electrode}$ and the $I^{electrode}$ on each electrodes to calculate the effective voltage on the electrode during the high-flux irradiation:

$$V_{eff}^{electrode} = V_{bias}^{electrode} - I^{electrode} \times R^{electrode}$$

II. Calculate the discrepancy with respect to the electrode voltage $(V_{nominal}^{electrode})$ at the nominal effective gas gain of 2×10^4 :

$$V_{err}^{electrode} = V_{nominal}^{electrode} - V_{eff}^{electrode}$$

III. increase iteratively each electrode voltage by $V_{err}^{electrode}$ until:

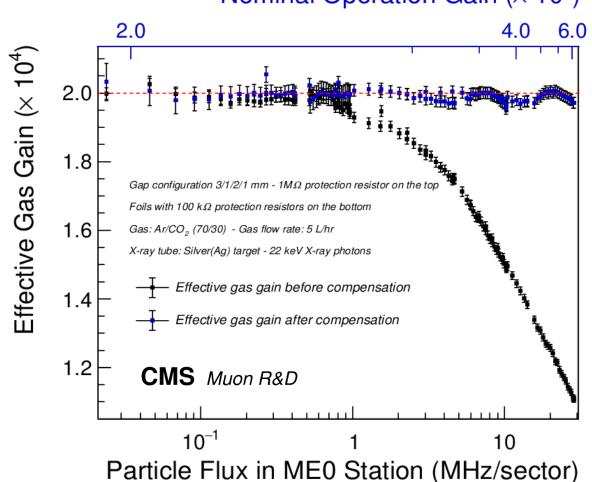
$$V_{eff}^{electrode} = V_{nominal}^{electrode}$$



Data Analysis (III): Gas Gain Compensation

Results after implementing the compensation algorithm:





A LabView-based virtual instrument was developed to implement the compensation algorithm for each value of irradiation flux.

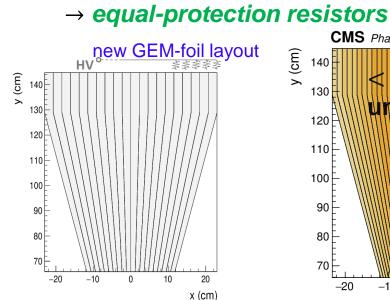
If the irradiation stops the gain increases because of the lack of currents through the resistors!

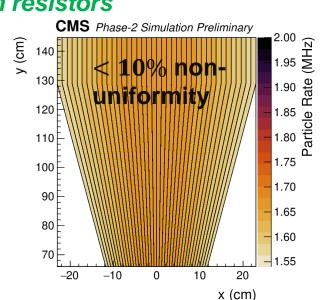


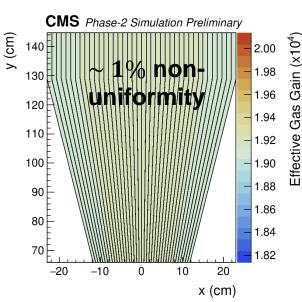
Radial Segmentation of the GEM-foils

The gas gain drop will be minimized by dividing each GEM foil in several *high-voltage sectors* along the *azimuthal-direction*.

- Each high-voltage sector connected separately, in order to limit the total current flowing through each protection resistor
 - \rightarrow equal-area sectors: < 100 cm² (To reduce the discharge energy)
- The background particle rate is approximately the same on each sector.
 Not affected by the shape of the background hit rate (slide 5).



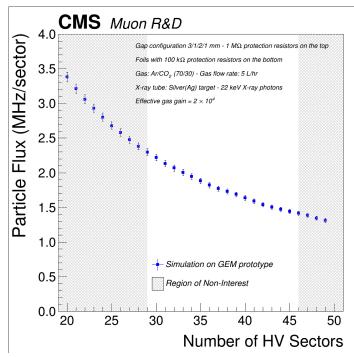


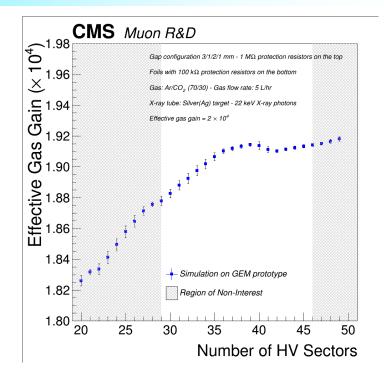


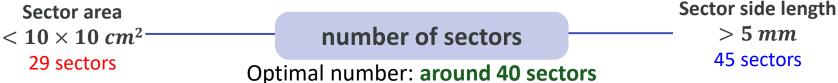
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Radial Segmentation of the GEM-foils







The *hit rate per sector* in the CMS-ME0 background can be contained to an average of 1.5 *MHz/sector*, while the *gas gain drop* can be minimized to about 10% of the nominal value of 2×10^4 .

The studies presented show a new approach on the rate capability problem of triple-GEM detectors, applied to the high-rate environment expected for the innermost muon station of the CMS endcaps for the high-luminosity upgrade:

- The rate capability of large-area triple-GEM based detectors has been demonstrated to be limited by the protection resistors;
- The measured gas gain drops can be as high as 40% of the expected gas gain, which can be recovered by applying overvoltage to the detector electrodes and maintaining the nominal electric fields between the foils and gaps;
- The main mitigation strategy chosen for the CMS-ME0 detectors involves a radial segmentation of the GEM-foils with respect to the beam line: such redesign is expected to reduce the gas gain loss during CMS operations not higher than 10%.



Thank you!





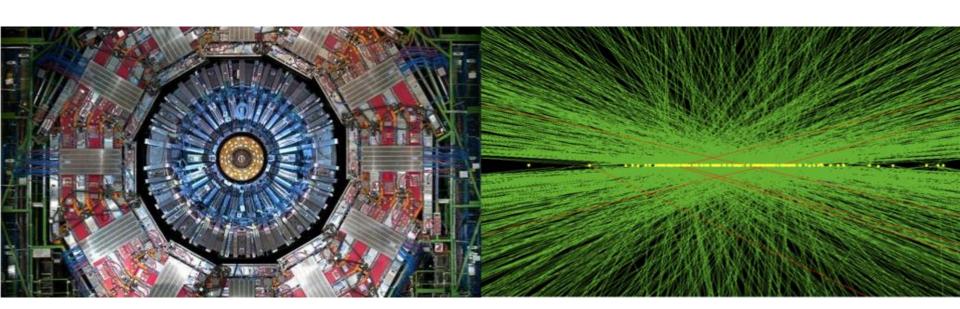




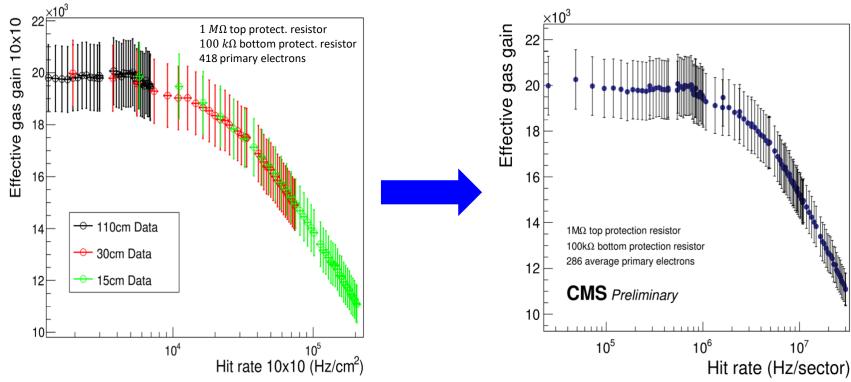




BACKUP SLIDES







Lessons learned from measurement

- Gain drop depends on the total (integral) hit rate on the sector, not on the flux → rate expressed in Hz/sector instead of Hz/cm²
- Gain drop depends on total current on electrode (which is proportional to n.primaries × hit rate)

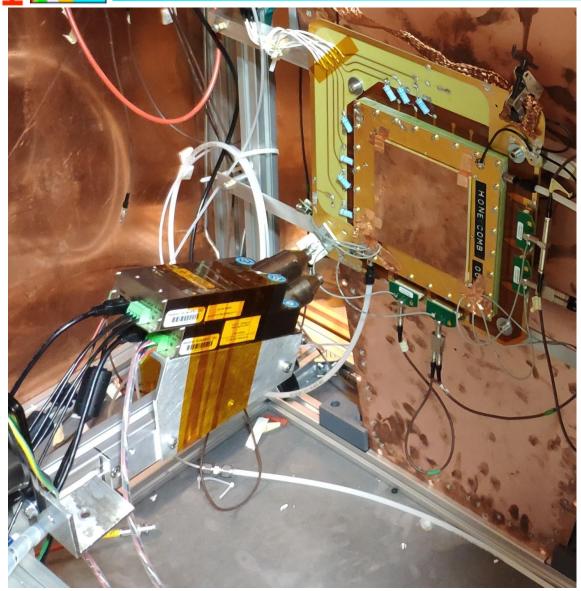
For the CMS environment

Rate axis scaled by $\frac{primaries_{X-ray}}{primaries_{ME0}} = \frac{418}{286}$

ightarrow For a *known hit rate* on a sector of an ME0 chamber in the CMS environment background, we can *foresee the sector gain drop* (only in the 1M Ω configuration) using the rate capability curve



Experimental setup



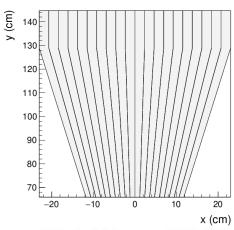


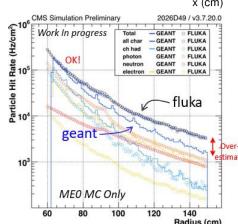
Large-area GEM detector design

Longitudinal segmentation

Bkg. independent







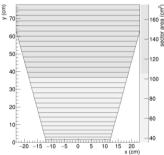
Transversal segmentation

NO Bkg. independent



Backup solution

HV areas and protection resistors have to be tuned to equalize the voltage drop under irradiation (studies are ongoing)



Constraints on HV sector areas

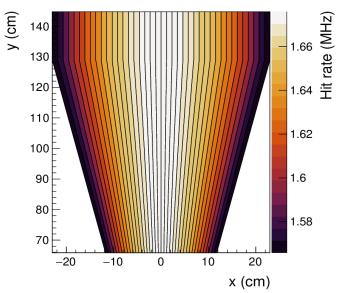
- Largest area limited by discharge and short circuit probability
- Minimum area limited by design and production machinery, available space for resistors

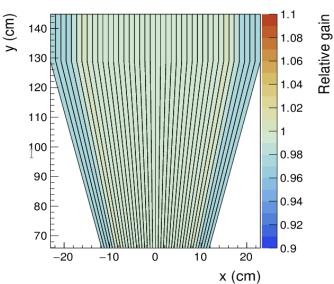
Constrains on protection resistors

- Minimum resistor determined by discharge protection and short-circuit current, to avoid too much current load on HVPS
- Maximum resistor limited by rate capability, depending on hit rate on specific sector



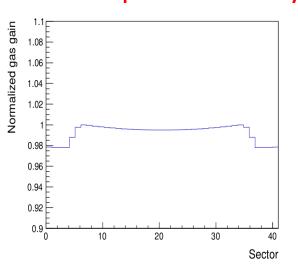
Vertical segmentations: rate and gain

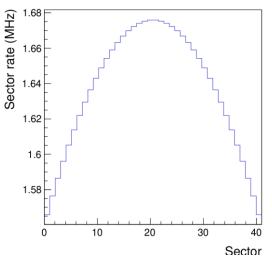




Example phi-segmentation with 40 sectors

- 1. Hit rate from background simulation
- 2. Gain **drop from rate capability** measurement
- All sector areas are exactly the same (each sector is a trapezoid + a rectangle)
- Sector rates are not exactly the same (flux shape is radially symmetrical, while segmentation is not)
- \rightarrow Gain is not exactly the same for all sector But anyway, the gain disuniformity (\sim 1%) due to different drops appears to be much lower than average intrinsic chamber response disuniformity (\leq 15%)!





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MEO GEM-foil layout - baseline

So just to recap our mitigation strategies:

Double-sided segmented GEM-foils

- \rightarrow vertical foil segmentation (along φ -coordinate)
- ightarrow average the radiation load along r-coordinate and make the interaction rate on all HV sectors the same
- → background independent model (i.e., all the rates will move up or down together in parallel with any changes in the radial radiation profile)

40 "trapezoidal + rectangular" HV sectors

- \rightarrow maximum safe surface $\sim 100 \ cm^2$ to reduce the discharge energy
- \rightarrow the rate is expected to be $24~kHz/cm^2$ on each sector or about 2.4~MHz total per sector assuming each area sector is $100~cm^2$
- \rightarrow the gas gain is expected to vary less than 1% from sector to sector

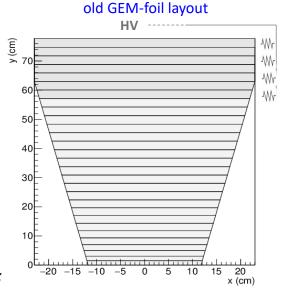
HV distribution and SMD components on the top of the GEM-foils

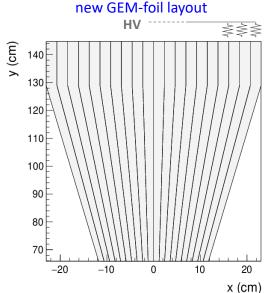
→ greater active area overlap in adjacent chambers

Protection resistors value - baseline:

$1~M\Omega$ on the top-foil & $100~k\Omega$ on the bottom-foil

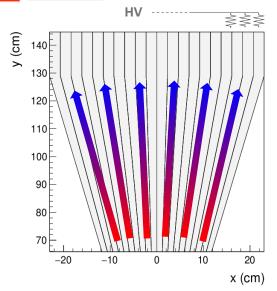
- → ensure prevention/protection against self-sustained discharges
- ightarrow minimize the voltage drop across the GEM-foil during high-flux irradiation
- \rightarrow avoid exceeding the current limit imposed by the power supply on each HV channel in case of short-circuit (n.b.: possibility of having different protect. resistor values between the GEM_{1,2,3}-foils was considered)







Concerns and possible tests on φ -segmentation

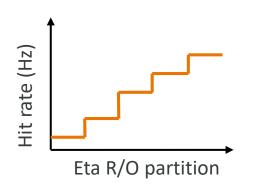


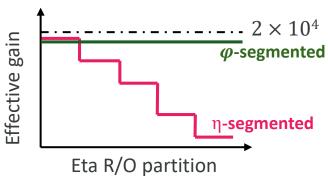
A concern: by powering the chamber at low eta, there is a constant current of $O(\mu A)$ flowing from high to low eta for charge evacuation

- Copper conductivity too high to give voltage drops along eta
- Possibly current flowing through GEM₃ bottom giving rise to distortions on signal?
 - → will be tested by checking the new prototype!

A possible test: chamber irradiated with X-ray source placed at high eta (rate profile decreasing as ~1/y2)

- Traditional ME0 prototype (η -segmentation) \rightarrow gain should decrease with η -coordinate
- New MEO prototype (φ -segmentation) \rightarrow gain expected constant along φ -coordinate



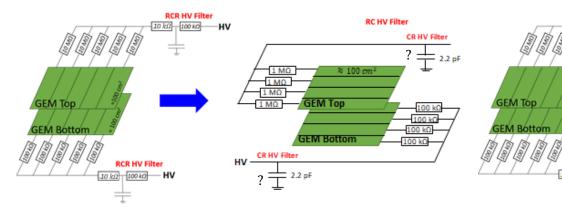


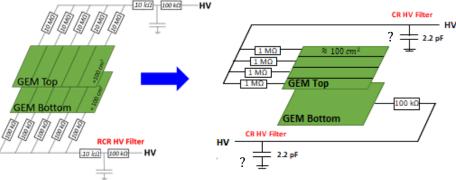


GEM-foil design vs. stack optimization

ME0 GEM₁ & GEM₂ foil baseline

MEO GEM₃ foil baseline





OLD GEM_{1,2} - foil layout

NEW GEM_{1,2} - foil layout

OLD GEM₃ - foil layout

NEW GEM₃ - foil layout

- → **double-segmentation** of the **GEM**₁ and **GEM**₂ foils to limit the energy available to feed the discharge propagation
- → resistive high-voltage filter redesign to minimize the voltage drop during the high-flux irradiation

Idea: use the *foil protection resistors* in a *dual role* as part of the *high-voltage resistive filter* and *protection circuit* (i.e. instead of an external RCR low-pass filter, use a simpler CR circuit)

- \rightarrow *unique electrode* for the *GEM*₃ with a single protection resistor (> $100~k\Omega$): promising option to cope with *X-talk issue*
- ightarrow a single protection resistor as a part of the CR low-pass filters and protection circuit to limit the discharge inside the foil
- → discharge phenomena, rate capability, power supply limit must be taken into account to choose the protect. resistor value